

0.5A, 50V - 1000V Fast Recovery Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- High temperature metallurgically bonded construction
- Fast switching for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

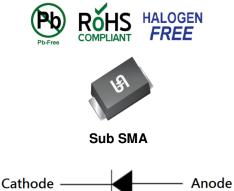
APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- General purpose

MECHANICAL DATA

- Case: Sub SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.019g (approximately)

KEY PARAMETERS					
PARAMETER VALUE UNIT					
١ _F	0.5	А			
V _{RRM}	50 - 1000	V			
I _{FSM}	10	А			
T _{J MAX}	150	°C			
Package	Sub SMA				
Configuration	Single die				



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)									
PARAMETER	SYMBOL	RSF AL	RSF BL	RSF DL	RSF GL	RSF JL	RSF KL	RSF ML	UNIT
Marking code on the device		FAL	FBL	FDL	FGL	FJL	FKL	FML	
Repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	140	280	420	560	700	V
Forward current	١ _F	0.5			Α				
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	10			A				
Junction temperature	TJ	- 55 to +150			°C				
Storage temperature	T _{STG}	- 55 to +150			°C				



THERMAL PERFORMANCE						
PARAMETER	SYMBOL	ТҮР	UNIT			
Junction-to-case thermal resistance	R _{eJC}	32	°C/W			
Junction-to-ambient thermal resistance	R _{eJA}	150	°C/W			

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾		$I_F = 0.5A, T_J = 25^{\circ}C$	V _F	-	1.3	V
Reverse current @ rated $V_R^{(2)}$		$T_J = 25^{\circ}C$	I _R	-	5	μA
		T _J = 125°C		-	50	μA
Junction capacitance		1MHz, V _R = 4.0V	CJ	4	-	pF
Reverse recovery time	RSFAL RSFBL RSFDL RSFGL	IF = 0.5A, IR = 1.0A, I _{rr} = 0.25A	t _{rr}	-	150	ns
	RSFJL			-	250	ns
	RSFKL RSFML			-	500	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING			
RSFxL	Sub SMA	10,000 / Tape & Reel			

Notes:

1. "x" defines voltage from 50V(RSFAL) to 1000V(RSFML)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

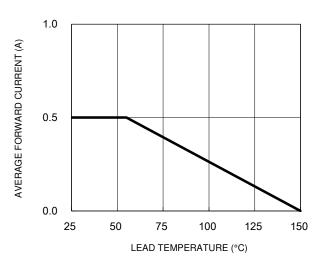


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics

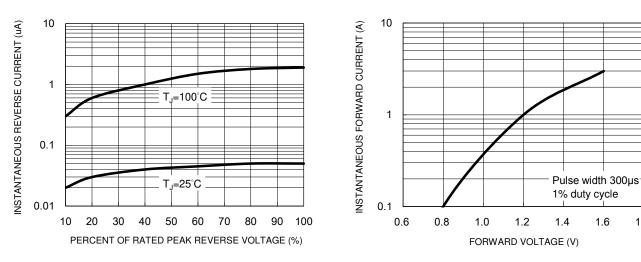


Fig.5 Maximum Non-Repetitive Forward Surge Current

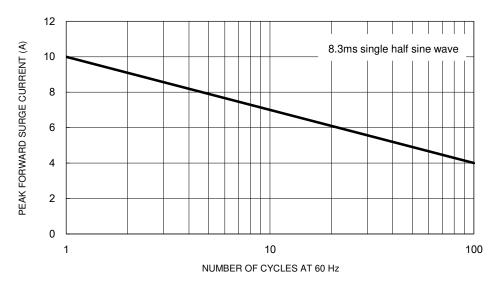


Fig.2 Typical Junction Capacitance

10

Fig.4 Typical Forward Characteristics

REVERSE VOLTAGE (V)

100

1.8

10

1

1

f=1.0MHz Vsig=50mVp-p

CAPACITANCE (pF)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

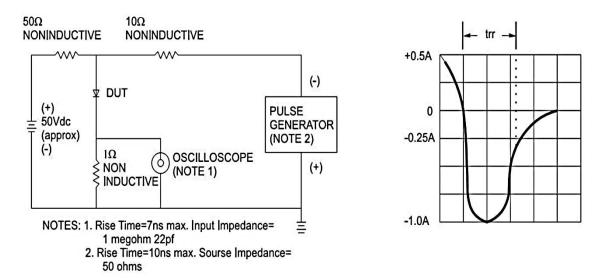


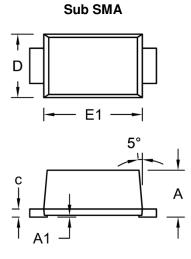
Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

RSFAL – RSFML Taiwan Semiconductor

Unit (inch)



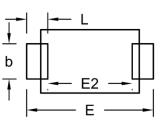
PACKAGE OUTLINE DIMENSIONS



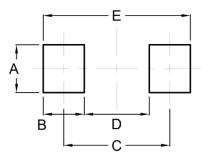
DIM.	Min.	Max.	Min.	Max.	
А	1.23	1.43	0.048	0.056	
A1	0.00	0.10	0.000	0.004	
b	0.80	1.20	0.031	0.047	
с	0.16	0.30	0.006	0.012	
D	1.70	1.90	0.067	0.075	
Е	3.40	3.80	0.134	0.150	
E1	2.70	2.90	0.106	0.114	
E2	2.45	2.60	0.096	0.102	
L	0.35	0.85	0.014	0.033	

Unit (mm)

DIM.



SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.40	0.055
В	1.20	0.047
С	3.10	0.122
D	1.90	0.075
E	4.30	0.169

MARKING DIAGRAM



P/N	= Marking	Code
1 / 1 1	- manning	oouc

G = Green Compound

YW = Date Code

F = Factory Code



RSFAL – RSFML

Taiwan Semiconductor

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